

27C16 16,384-Bit (2048 x 8) UV Erasable CMOS PROM Military Qualified

General Description

The 27C16 is a high speed 16K UV erasable and electrically reprogrammable CMOS EPROM, ideally suited for applications where fast turnaround, pattern experimentation and low power consumption are important requirements.

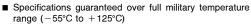
The 27C16 is packaged in a 24-pin dual-in-line package with transparent lid. The transparent lid allows the user to expose the chip to ultraviolet light to erase the bit pattern. A new pattern can then be written into the device by following the programming procedure.

This EPROM is fabricated with the reliable, high volume, time proven, P²CMOSTM silicon gate technology.

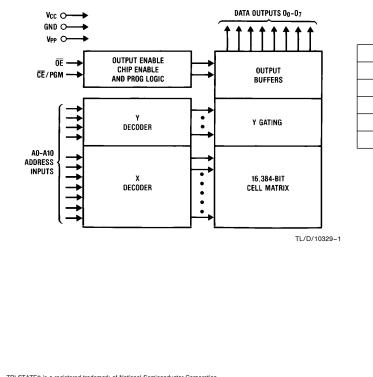
The 27C16 specified on this data sheet is fully compliant with MIL-STD-883, Revision C.

Features

- Access time down to 450 ns
- Low CMOS power consumption
- Active Power: 26.25 mW max
 Standby Power: 0.53 mW max (98% savings)
- Performance compatible to NSC800TM CMOS microprocessor
- Single 5V power supply
- Pin compatible to MM2716 and higher density EPROMs
- Static—no clocks required
- TTL compatible inputs/outputs
- TRI-STATE® output
- Windowed DIP Package



Block Diagram



Pir	Pin Names					
A0-A10	Addresses					
CE	Chip Enable					
ŌĒ	Output Enable					
O ₀ -O ₇	Outputs					
PGM	Program					
NC	No Connect					

27C16 16,384-Bit (2048 x 8) UV Erasable CMOS PROM Military Qualified

January 1989

TRI-STATE® is a registered trademark of National Semiconductor Corporation. NS800™ are P2CMOS™ trademarks of National Semiconductor Corporation.

©1995 National Semiconductor Corporation TL/D/10329

RRD-B30M105/Printed in U. S. A.

27C256	27C128	27C64	27C32				27C32	27C64	27C128	2725
27256	27128	2764	2732				2732	2764	27128	2725
V _{PP}	V _{PP}	V _{PP}		Du	al-In-Line Pack	age		V _{CC}	V _{CC}	Vcc
A12	A12	A12			27C16Q	_		PGM	PGM	A14
A7	A7	A7	A7	A7	1	24 VGC	V _{CC}	NC	A13	A13
A6	A6	A6	A6	A6	2	23 — AB	A8	A8	A8	A8
A5	A5	A5	A5	A5	3	22 A9	A9	A9	A9	A9
A4	A4	A4	A4	A4	4	21 - VPP	A11	A11	A11	A11
A3	A3	A3	A3	A3 —	5	20 — ÖE	$\overline{\text{OE}}/\text{V}_{\text{PP}}$	ŌĒ	ŌĒ	OE
A2	A2	A2	A2	A2	6	19 — A10	A10	A10	A10	A10
A1	A1	A1	A1	A1	7	18 - CE	CE	CE	CE	CE
A0	A0	AO	A0	A0	8	17 - 07	07	O ₇	07	07
O ₀	O ₀	O ₀	O ₀	0 ₀ —	9	16 06	0 ₆	0 ₆	0 ₆	06
0 ₁	01	01	O ₁	01	10	15 05	O ₅	O ₅	O ₅	05
O ₂	0 ₂	O ₂	O ₂	02	11 1	14 04	O ₄	O ₄	O ₄	04
GND	GND	GND	GND	GND	12	13 03	O3	O3	O3	O ₃

TL/D/10329-2

Note: Socket compatible EPROM pin configurations are shown in the blocks adjacent to the 27C16 pins.

Military Temp Range (-55°C to $\,+\,125^\circ\text{C}$) V_{CC}=\,5V\,\pm\,10\,\%

Parameter/Order Number	Access Time (ns)
27C16Q450/883	450
27C16Q550/883	550

Absolute Maximum Ratings (Note 1)

	
Temperature Under Bias	-55°C to +125°C
Storage Temperature	-65°C to +125°C
All Input Voltages with Respect to Ground	+6.5V to $-0.3V$
All Output Voltages with Respect to Ground (Note 11)	V_{CC} $\pm 0.3V$ to GND $-0.3V$
V _{PP} Supply Voltage with Respect to Ground during Programming	+ 26.5V to -0.3V
Power Dissipation	1.0W
Lead Temperature (Soldering, 10 Seconds)	300°C

Operating Conditions (Note 9)

• •	
Temperature Range	(T _{case})
V _{CC} Power Supply (N	lotes 2 and 3
V _{PP} Power Supply (N	lote 3)

 $\begin{array}{c} -55^{\circ}\text{C to} + 125^{\circ}\text{C} \\ \text{d 3)} & 5\text{V} + 10\% \\ \text{V}_{\text{CC}} \end{array}$

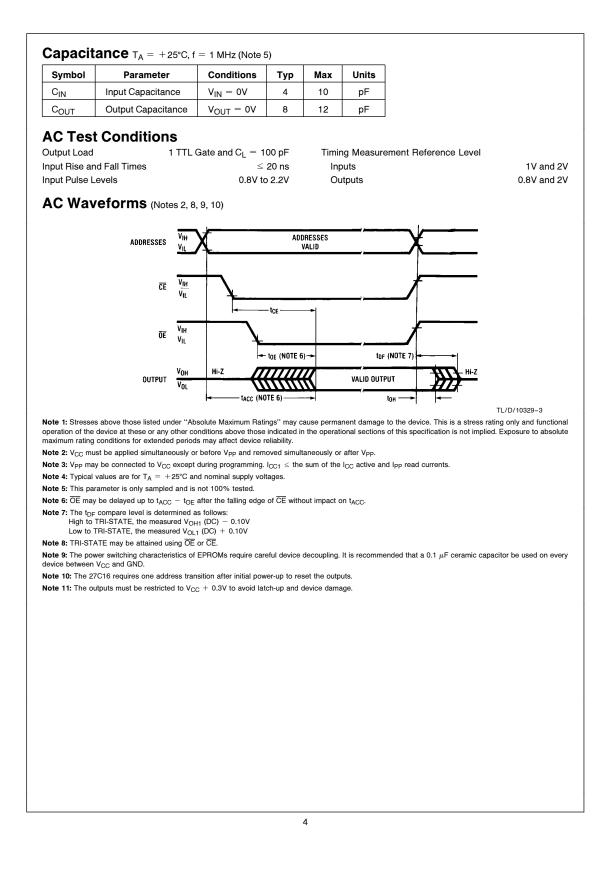
READ OPERATION

DC Electrical Characteristics

Symbol	Parameter	Conditions	Min	Typ (Note 4)	Мах	Units
ILI	Input Load Current	$V_{IN} = V_{CC} \text{ or } V_{IL}$			10	μΑ
I _{LO}	Output Leakage Current	$V_{OUT} = V_{CC} \text{ or } V_{IL}, \overline{CE} = V_{IH}$			10	μΑ
I _{CC1} (Note 3)	V _{CC} Current (Active) TTL Inputs	$\label{eq:observation} \begin{split} \overline{OE} &= \overline{CE} = V_{IL}, \text{f} = 1 \text{ MHz} \\ \text{Inputs} &= V_{IH} \text{ or } V_{IL}, \text{I/O} = 0 \text{ mA} \end{split}$		2	30	mA
I _{CC2} (Note 3)	V _{CC} Current (Active) CMOS Inputs	$\overline{OE} = \overline{CE} = V_{IL}$, f = 1 MHz Inputs = V _{CC} or GND, I/O = 0 mA		1	25	mA
I _{CCSB1}	V _{CC} Current (Standby) TTL Inputs	$\overline{CE} = V_{IH}$		0.1	1	mA
I _{CCSB2}	V _{CC} Current (Standby) CMOS Inputs	$\overline{CE} = V_{CC}$		0.01	0.1	mA
V _{IL}	Input Low Voltage		-0.1		0.8	V
VIH	Input High Voltage		2.2		$V_{CC} + 1$	V
V _{OL1}	Output Low Voltage	$I_{OL} = 2.1 \text{ mA}$			0.45	V
V _{OH1}	Output High Voltage	$I_{OH} = -400 \ \mu A$	2.4			V
V _{OL2}	Output Low Voltage	$I_{OL} = 0 \ \mu A$			0.1	V
V _{OH2}	Output High Voltage	$I_{OH} = 0 \ \mu A$	4.4			V

AC Electrical Characteristics

Symbol	Parameter	Conditions	450		550		Units
			Min	Max	Min	Max	
t _{ACC}	Address to Output Delay	$\overline{CE} = \overline{OE} = V_{IL}$		450		550	ns
t _{CE}	CE to Output Delay	$\overline{OE} = V_{IL}$		450		550	ns
t _{OE}	OE to Output Delay	$\overline{CE} = V_{IL}$		120		120	ns
t _{DF}	OE High to Output Float	$\overline{CE} = V_{IL}$	0	100	0	100	ns
t _{OH} (Note 5)	Output Hold from Addresses, CE or OE, Whichever Occurred First	$\overline{CE} = \overline{OE} = V_{IL}$	0		0		ns



PROGRAMMING CHARACTERISTICS (Note 1)

DC Programming Characteristics (Notes 2 & 3) (T_A = $\pm 25^{\circ}C \pm 5^{\circ}C$, V_{CC} = 5V $\pm 10^{\circ}$, V_{PP} = 25V $\pm 1V$)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
ILI	Input Current (for Any Input)	$V_{IN} = V_{CC} \text{ or } GND$			10	μA
IPP	V _{PP} Supply Current during Programming Pulse	$\overline{\text{CE}}/\text{PGM} = \text{V}_{\text{IH}}$			30	mA
ICC	V _{CC} Supply Current				10	mA
V _{IL}	Input Low Level		-0.1		0.8	V
VIH	Input High Level		2.0		V _{CC} + 1	V

AC Programming Characteristics (Notes 2 & 3) (T_A = $\pm 25^{\circ}C \pm 5^{\circ}C$, V_{CC} = 5V $\pm 10^{\circ}$, V_{PP} = 25V $\pm 1V$)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
t _{AS}	Address Setup Time		2			μs
tOES	OE Setup Time		2			μS
t _{DS}	Data Setup Time		2			μs
t _{AH}	Address Hold Time		2			μs
t _{OEH}	OE Hold Time		2			μs
t _{DH}	Data Hold Time		2			μs
t _{DF}	Output Enable to Output Float Delay	$\overline{\text{CE}}/\text{PGM} = \text{V}_{\text{IL}}$	0		120	ns
t _{OE}	Output Enable to Output Delay	$\overline{\text{CE}}/\text{PGM} = \text{V}_{\text{IL}}$			100	ns
t _{PW}	Program Pulse Width		45	50	55	ms
t _{PRT}	Program Pulse Rise Time		5			ns
t _{PFT}	Program Pulse Fall Time		5			ns

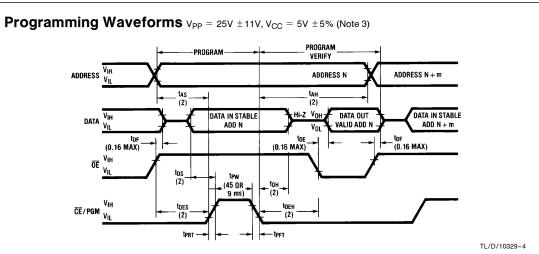
AC Test Conditions

 V_{CC} V_{PP} Input Rise and Fall Times Input Pulse Levels

5V ±10% $25V \pm 1V$ \leq 20 ns 0.8V to 2.2V

Timing Measurement Reference Level Inputs Outputs

1V and 2V 0.8V and 2V



Note: All times shown in parentheses are minimum and in μ s unless otherwise specified.

Note 1: National's standard product warranty applies only to devices programmed to specifications described herein.

Note 2: V_{CC} must be applied simultaneously or before V_{PP} and removed simultaneously or after V_{PP}. The 27C16 must not be inserted into or removed from a board with V_{PP} at 25V ±1V to prevent damage to the device.

Note 3: The maximum allowable voltage which may be applied to the V_{PP} pin during programming is 26V. Care must be taken when switching the V_{PP} supply to prevent overshoot exceeding this 26V maximum specification. A 0.1 µF capacitor is required across V_{PP}, V_{CC} to GND to suppress spurious voltage transients which may damage the device.

Functional Description

DEVICE OPERATION

The six modes of operation of the 27C16 are listed in Table I. It should be noted that all inputs for the six modes are at TTL levels. The power supplies required are a 5V V_{CC} and a V_{PP}. The V_{PP} power supply must be at 25V during the three programming modes, and must be at 5V in the other three modes.

Read Mode

The 27C16 has two control functions, both of which must be logically active in order to obtain data at the outputs. Chip Enable ($\overline{\text{CE}}$) is the power control and should be used for device selection. Output Enable ($\overline{\text{OE}}$) is the output control and should be used to gate data to the output pins, independent of device selection. Assuming that addresses are stable, address access time (t_{ACC}) is equal to the delay from $\overline{\text{CE}}$ to output (t_{CE}). Data is available at the outputs t_{OE} after the falling edge of $\overline{\text{OE}}$, assuming that $\overline{\text{CE}}$ has been low and addresses have been stable for at least $t_{ACC}-t_{OE}$. The 27C16 requires one address transition after initial power-up to reset the outputs.

Standby Mode

The 27C16 has a standby mode which reduces the active power dissipation by 98%, from 26.25 mW to 0.53 mW. The 27C16 is placed in the standby mode by applying a TTL high signal to the $\overline{\text{CE}}$ input. When in standby mode, the outputs are in a high impedance state, independent of the $\overline{\text{OE}}$ input.

Output OR-Tying

Because 27C16s are usually used in larger memory arrays, National has provided a 2-line control function that accommodates this use of multiple memory connections. The 2-line control function allows for:

a) the lowest possible memory power dissipation, and

b) complete assurance that output bus contention will not occur.

To most efficiently use these two control lines, it is recommended that \overline{CE} (pin 18) be decoded and used as the primary device selecting function, while \overline{OE} (pin 20) be made a common connection to all devices in the array and connected to the READ line from the system control bus. This assures that all deselected memory devices are in their low power standby modes and that the output pins are active only when data is desired from a particular memory device.

Programming

CAUTION: Exceeding 26.5V on pin 21 (V_PP) will damage the 27C16.

Initially, and after each erasure, all bits of the 27C16 are in the "1" state. Data is introduced by selectively programming "0s" into the desired bit locations. Although only "0s" will be programmed, both "1s" and "0s" can be presented in the data word. The only way to change a "0" to a "1" is by ultraviolet light erasure.

The 27C16 is in the programming mode when the V_{PP} power supply is at 25V and \overline{OE} is at V_{IH}. It is required that a 0.1 μF capacitor be placed across V_{PP}, V_{CC} to ground to suppress spurious voltage transients which may damage the device. The data to be programmed is applied 8 bits in parallel to the data output pins. The levels required for the address and data inputs are TTL.

When the address and data are stable, a 50 ms, active high, TTL program pulse is applied to the \overline{CE}/PGM input. A program pulse must be applied at each address location to be programmed. You can program any location at any time—either individually, sequentially, or at random. The program pulse has a maximum width of 55 ms. The 27C16 must not be programmed with a DC signal applied to the \overline{CE}/PGM input.

Functional Description (Continued)

Programming multiple 27C16s in parallel with the same data can be easily accomplished due to the simplicity of the programming requirements. Like inputs of the paralleled 27C16s may be connected together when they are programmed with the same data. A high level TTL pulse applied to the \overline{CE} /PGM input programs the paralleled 27C16s.

Program Inhibit

Programming multiple 27C16s in parallel with different data is also easily accomplished. Except for \overline{CE}/PGM , all like inputs (including \overline{OE}) of the parallel 27C16s may be common. A TTL level program pulse applied to an 27C16's \overline{CE}/PGM input with V_{PP} at 25V will program that 27C16. A low level \overline{CE}/PGM input inhibits the other 27C16 from being programmed.

Program Verify

A verify should be performed on the programmed bits to determine whether they were correctly programmed. The verify may be performed with V_{PP} at 25V. V_{PP} must be at V_{CC}, except during programming and program verify.

ERASURE CHARACTERISTICS

The erasure characteristics of the 27C16 are such that erasure begins to occur when exposed to light with wavelengths shorter than approximately 4000 Angstroms (Å). It should be noted that sunlight and certain types of fluorescent lamps have wavelengths in the 3000Å-4000Å range. Opaque labels should be placed over the 27C16 window to prevent unintentional erasure. Covering the window will also prevent temporary functional failure due to the generation of photo currents.

The recommended erasure procedure for the 27C16 is exposure to short wave ultraviolet light which has a wavelength of 2537 Angstroms (Å). The integrated dose (i.e., UV intensity \times exposure time) for erasure should be a minimum of 15W-sec/cm². The erasure time with this dosage is approximately 21 minutes using an ultraviolet lamp with a

12,000 $\mu\text{W/cm}^2$ power rating. The 27C16 should be placed within 1 inch of the lamp tubes during erasure. Some lamps have a filter on their tubes which should be removed before erasure.

Note: The 27C16-550 may take up to 60 minutes for complete erasure to occur.

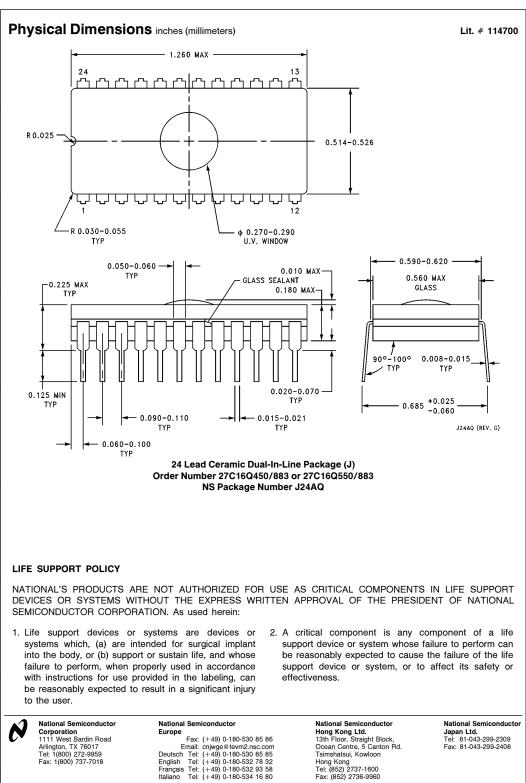
An erasure system should be calibrated periodically. The distance from lamp to unit should be maintained at one inch. The erasure time increases as the square of the distance. (If distance is doubled the erasure time increases by a factor of 4.) Lamps lose intensity as they age. When a lamp is changed, the distance has changed, or the lamp has aged, the system should be checked to make certain full erasure is occurring. Incomplete erasure will cause symptoms that can be misleading. Programmers, components, and even system designs have been erroneously suspected when incomplete erasure was the problem.

SYSTEM CONSIDERATION

The power switching characteristics of EPROMs require careful decoupling of the devices. The supply current, ICC, has three segments that are of interest to the system designer-the standby current level, the active current level, and the transient current peaks that are produced on the falling and rising edges of chip enable. The magnitude of these transient current peaks is dependent on the output capacitance loading of the device. The associated transient voltage peaks can be suppressed by properly selected decoupling capacitors. It is recommended that a 0.1 µF ceramic capacitor be used on every device between $V_{\mbox{CC}}$ and GND. This should be a high frequency capacitor of low inherent inductance. In addition, a 4.7 µF bulk electrolytic capacitor should be used between $V_{\mbox{\scriptsize CC}}$ and GND for each eight devices. The bulk capacitor should be located near where the power supply is connected to the array. The purpose of the bulk capacitor is to overcome the voltage drop caused by the inductive effects of the PC board traces.

TABLE I. Mode Selection							
Pins Mode	CE/PGM (18)	OE (20)	V _P (21)	V _{CC} (24)	Outputs (9-11, 13-17)		
Read	V _{IL}	VIL	V _{CC}	5	D _{OUT}		
Standby	V _{IH}	Don't Care	V _{CC}	5	Hi-Z		
Program	Pulsed V_{IL} to V_{IH}	V _{IH}	25	5	D _{IN}		
Program Verify	V _{IL}	VIL	25	5	D _{OUT}		
Program Inhibit	V _{IL}	V _{IH}	25	5	Hi-Z		
Output Disable	Х	VIH	V _{CC}	5	Hi-Z		

7



National does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and National reserves the right at any time without notice to change said circuitry and specifications.



ООО "ЛайфЭлектроникс"

ИНН 7805602321 КПП 780501001 Р/С 40702810122510004610 ФАКБ "АБСОЛЮТ БАНК" (ЗАО) в г.Санкт-Петербурге К/С 3010181090000000703 БИК 044030703

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



Тел: +7 (812) 336 43 04 (многоканальный) Email: org@lifeelectronics.ru

www.lifeelectronics.ru